

BUREAU VERITAS  
Certification



## 江阴长电先进封装有限公司

中国江苏省江阴市滨江中路 275 号

统一社会信用代码：91320281753943521E

此份为多场所证书，各分场所见证书附页

必维认证集团认证控股有限公司英国分公司

确证上述单位的管理体系已经评审

并确认符合下列管理体系标准全部适用条款的要求

## ISO 14001:2015

体系覆盖范围

半导体芯片凸块封装及 3D 封装测试制造

最初认证周期起始日期：2006 年 8 月 21 日  
上一周期的到期日：NA  
再认证审核日期：NA  
再认证周期起始日期：2018 年 8 月 21 日

在证书持有者之管理体系持续符合要求的运行条件下，本证书至下述日期有效：  
2021 年 8 月 20 日

证书号：CNBJ312846-UK

版本号：No.1，批准日期：2018 年 8 月 12 日

必维认证集团认证控股有限公司英国分公司  
授权代表



008

认证机构地址：5<sup>th</sup> Floor, 66 Prescot Street, London E1 8HG, United Kingdom

当地办公室地址：中国北京市东城区北三环东路36号北京环球贸易中心B座22层，邮编：100013

需进一步澄清本证书认证范围及此管理体系要求的适用性，可直接向持证者查询。

要查证本证书之有效状态请电：(+86 10 59683663)

获证组织必须定期接受监督审核并经审核合格此证书方继续有效。本证书信息可在国家认证认可监督管理委员会官方网站([www.cnca.gov.cn](http://www.cnca.gov.cn))上查询。

BUREAU VERITAS  
Certification



## 江阴长电先进封装有限公司

### ISO 14001:2015

体系覆盖范围

半导体芯片凸块封装及 3D 封装测试制造

场所名称	场所加入日期	场所地址	场所认证范围
江阴长电先进封装有限公司	2006 年 8 月 21 日	中国江苏省江阴市高新技术产业开发区 (澄江东路 99 号)	仅为注册地址
江阴长电先进封装有限公司	2006 年 8 月 21 日	中国江苏省江阴市滨江中路 275 号	半导体芯片凸块封装及 3D 封装测试制造
江阴长电先进封装有限公司	2017 年 7 月 18 日	中国江苏省江阴市长山大道 78 号	半导体芯片凸块封装及 3D 封装测试制造

证书号: CNBJ312846-UK

版本号: No.1, 批准日期: 2018 年 8 月 12 日

必维认证集团认证控股有限公司英国分公司  
授权代表



008

认证机构地址: 5<sup>th</sup> Floor, 66 Prescot Street, London E1 8HG, United Kingdom

当地办公室地址: 中国北京市东城区北三环东路36号北京环球贸易中心B座22层, 邮编: 100013

需进一步澄清本证书认证范围及此管理体系要求的适用性, 可直接向持证者查询。

要查证本证书之有效状态请电: (+86 10 59683663)

获证组织必须定期接受监督审核并经审核合格此证书方继续有效。本证书信息可在国家认证认可监督管理委员会官方网站([www.cnca.gov.cn](http://www.cnca.gov.cn))上查询。



**BUREAU VERITAS**  
Certification



## **JIANGYIN CHANGDIAN ADVANCED PACKAGING CO., LTD.**

NO.275, BINJIANG MIDDLE ROAD, JIANGYIN CITY, JIANGSU PROVINCE, P. R. CHINA

Unified social credit code: 91320281753943521E

This is a multi-site certificate, additional site details are listed in the appendix to this certificate

*Bureau Veritas Certification Holding SAS - UK Branch certifies that the Management System of the above organisation has been audited and found to be in accordance with the requirements of the management system standards detailed below*

### **ISO 14001:2015**

*Scope of certification*

#### **WAFER BUMPING AND WAFER LEVEL CHIP SCALE PACKAGES / 3D PACKAGES WITH TESTING**

Original cycle start date:	<b>21 AUGUST 2006</b>
Expiry date of previous cycle:	<b>NA</b>
Recertification audit date:	<b>NA</b>
Recertification cycle start date:	<b>21 AUGUST 2018</b>

Subject to the continued satisfactory operation of the organisation's Management System,  
this certificate expires on: **20 AUGUST 2021**

Certificate No. : **CNBJ312846-UK**

Version: **No.1**, Revision date: **12 AUGUST 2018**

**Signed on behalf of BVCH SAS UK Branch**



**008**

Certification body address: 5<sup>th</sup> Floor, 66 Prescott Street, London E1 8HG, United Kingdom.

Local office address: F22, Tower B, Beijing Global Trade Center, 36 North Third Ring Road East, Dongcheng District, Beijing, China. 100013.

Further clarifications regarding the scope of this certificate and the applicability of the management system requirements may be obtained by consulting the organisation.

To check this certificate validity please call: (+86 10 59683663)

Certified organisation has to accept and pass regular surveillance audits, then this certificate can be continuously valid. Information of this certificate may be obtained by visiting CNCA website ([www.cnca.gov.cn](http://www.cnca.gov.cn)).





## JIANGYIN CHANGDIAN ADVANCED PACKAGING CO., LTD.

### ISO 14001:2015

*Scope of certification*

#### WAFER BUMPING AND WAFER LEVEL CHIP SCALE PACKAGES / 3D PACKAGES WITH TESTING

<u>Site Name/Location</u>	<u>Site Addition Date</u>	<u>Site Address</u>	<u>Site Scope</u>
JIANGYIN CHANGDIAN ADVANCED PACKAGING CO., LTD.	21 AUGUST 2006	NO.99,CHANGJIANG EAST ROAD,HIGH TECHNOLOGY DEVELOPMENT INDUSTRY PARK,JIANGYIN CITY, JIANGSU PROVINCE, P. R. CHINA	Only Registered address
JIANGYIN CHANGDIAN ADVANCED PACKAGING CO., LTD.	21 AUGUST 2006	NO.275, BINJIANG MIDDLE ROAD, JIANGYIN CITY, JIANGSU PROVINCE, P. R. CHINA	WAFER BUMPING AND WAFER LEVEL CHIP SCALE PACKAGES / 3D PACKAGES WITH TESTING
JIANGYIN CHANGDIAN ADVANCED PACKAGING CO., LTD.	18 JULY 2017	NO.78, CHANGSHAN ROAD, JIANGYIN CITY, JIANGSU PROVINCE, P. R. CHINA	WAFER BUMPING AND WAFER LEVEL CHIP SCALE PACKAGES / 3D PACKAGES WITH TESTING

Certificate No. : **CNBJ312846-UK**

Version: **No.1**, Revision date: **12 AUGUST 2018**

**Signed on behalf of BVCH SAS UK Branch**

Certification body address: 5<sup>th</sup> Floor, 66 Prescott Street, London E1 8HG, United King

Local office address: F22, Tower B, Beijing Global Trade Center, 36 North Third Ring  
District, Beijing, China. 100013.



008 cheng

Further clarifications regarding the scope of this certificate and the applicability of the management system requirements may be obtained by consulting the organisation.

To check this certificate validity please call: (+86 10 59683663)

Certified organisation has to accept and pass regular surveillance audits, then this certificate can be continuously valid. Information of this certificate may be obtained by visiting CNCA website ([www.cnca.gov.cn](http://www.cnca.gov.cn)).